

| L Number | Hits | Search Text | DB | Time stamp |
|----------|------|--|---|---------------------|
| 16 | 3833 | ((low adj dielectric adj constant)or (low adj K)or SOG) same etch\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/02/16 14:57 |
| 23 | 2450 | ((low adj dielectric adj constant)or (low adj K)or SOG) same etch\$3) and ((low adj dielectric adj constant)or (low adj K)or SOG) with etch\$3 | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/02/16 14:57 |
| 30 | 17 | ((((low adj dielectric adj constant)or (low adj K)or SOG) same etch\$3) and ((low adj dielectric adj constant)or (low adj K)or SOG) with etch\$3) and (((low adj dielectric adj constant)or (low adj K)or SOG) same etch\$3 same ("Ch.sub.3 F")or "NH.sub.3")) | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB | 2002/02/16 16:34 |